



## Flexible organic devices: Towards ubiquitous electronics

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- Large area & flexible substrates possible
- Large variety of materials
- Low cost





#### Future Markets for Organic Devices

- IdTechex study:
- others Electrophoretic displays 🖌 • 330 billion US\$ in 2027 6% OLED panel 7% Iogic / memory 38% Most important markets: OLED lighting > ullet11% - Logic/Memory - OLED-Display 14% - Photovoltaics photovoltaic V 20% **OLED** display

#### Total market 2027: 330 billion US\$



#### **Progression of Organic Products**

3rd wave: Solar cells

2nd wave: OLED lighting



4th wave: Organic electronics



1st wave: OLED Displays









#### OLED display market forecasts – and the reality..



## OLED display market forecasts – and the reality..





#### The OLED 55' TV is coming...





#### OLED Lighting Demonstrators



Source: Novaled



## OLED lighting market forecasts

- OLED soon multibillion market?
- High efficiency crucial: 20-30lm/W reached >50lm/W required OLED
- Brightness at least 1000, ideally up to 5000 Cd/m<sup>2</sup>





## Carbon: the influence of dimensionality





#### Mobility as a function of disorder



- Rocking width correlates with mobility
- Even small disorder reduces μ strongly
- Conductivities are accordingly low



#### What determines OLED efficiency?

$$\eta_{external} = b_I \times \frac{h\nu}{eU} \times \eta_{recomb} \times \eta_{optical}$$

Outcoupling efficiency

- $b_l$ : Electron and hole current balance: 1 can be reached  $\sqrt{}$
- eU: Operating voltage should be  $\approx$  photon energy  $\sqrt{}$
- $\eta_{\text{recomb}}$ : 75% Triplet, 25% Singlet excitons: 0.25 for fluorescent emitter: Use phosphorescent emitters (Forrest/Thompson), optimize recombination zone  $\sqrt{}$
- $\eta_{\text{optical}}$ : about 20% in flat structure: 80% lost to wave guide modes



#### Distribution of Power in Modes



- Outcoupled modes
- Substrate modes (1)
- Organic modes (2)
- Plasmonic losses (3)





Source: Temicon



## Distribution of power into different modes

- Calculations by Mauro Furno (M. Furno et al. Proc. SPIE **7617**, 761716 (2010); Phys. Rev. B **85**, 115205 (2012))
- Model includes Purcell effect
- Model can be tested by variation of electron transport layer thickness



R. Meerheim et al., Appl. Phys. Lett. 97, 253305 (2010)



#### **Experiment: High Index Glass**





#### Results for White OLED









#### Results with high-index thin films



PUBLISHED ONLINE: 30 OCTOBER 2011 J DOI: 10.1038/NPHOTON.2011.259

# Unlocking the full potential of organic light-emitting diodes on flexible plastic

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#### Results with high-index thin films



- Extremely high quantum and power efficiency
- Approach not yet proven for white
- Z.B. Wang et al., Nature Photonics **5**, 753 (2011)

![](_page_19_Picture_0.jpeg)

- Flexible plastic substrates and thin organic layers
  - Low material and energy consumption
  - Short energy payback time
  - Potentially transparent, color adjustable
  - Compatible with low-cost large-area production technologies

![](_page_19_Picture_7.jpeg)

![](_page_19_Picture_8.jpeg)

![](_page_19_Picture_9.jpeg)

![](_page_19_Picture_10.jpeg)

![](_page_20_Picture_0.jpeg)

![](_page_20_Figure_2.jpeg)

- "Window of opportunity" in power market: 2015-2030
- What is needed: 10-12% in module = 15-17% in lab
- Lifetime at least 10 years

![](_page_21_Picture_0.jpeg)

Flat heterojunction (FHJ)

![](_page_21_Figure_2.jpeg)

bulk heterojunction (BHJ)

donor

acceptor

C. W. Tang, Appl. Phys. Lett. 48, 183 (1986)
M. Hiramoto et al., Appl. Phys. Lett. 58, 1062 (1991)
J. J. Hall et al., Nature 376, 498 (1995)
G. Yu et al. Science 270, 1789 (1995)

![](_page_22_Picture_0.jpeg)

#### New Thiophenes: DCV5T-Me Series

![](_page_22_Figure_2.jpeg)

![](_page_23_Picture_0.jpeg)

#### **DCV5T-Me Results**

![](_page_23_Figure_2.jpeg)

![](_page_24_Picture_0.jpeg)

Pin-tandem cells: doped layers are critical for optical optimization

![](_page_24_Figure_2.jpeg)

J. Drechsel et al., Appl.Phys.Lett. 86, 244102 (2005)

![](_page_25_Picture_0.jpeg)

#### Small-Molecule OPV Record > 1cm<sup>2</sup>

Leerlaufspannung:	V <sub>oc</sub>	=	(	1.6930	±	0.0085 )V
Kurzschlussstrom:	/ <sub>sc</sub>	=	(	9.08	±	0.23 ) mA
Füllfaktor:	FF	=	(	68.27	±	0.68 )%
Wirkungsgrad:	η	=	(	9.75	±	0.30 )%

![](_page_25_Figure_3.jpeg)

![](_page_26_Picture_0.jpeg)

- Standard measurement: 1 sun, 25 °C, perpendicular incidence
- Reality: 40-60 °C, often less than 1 sun, diffuse light
- Organics:
  - Positive temperature coefficient
  - Higher efficiency for lower intensity
  - Special diffuse light responsivity
- Sums up in the O-Factor: approx. 30% better!

![](_page_27_Picture_0.jpeg)

#### **Incident Angle Performance**

![](_page_27_Figure_2.jpeg)

![](_page_27_Picture_3.jpeg)

High independence on incident angle: Efficiency development from 0 to 60° above the expected values of pure geometrical consideration

- Heliatek Absorber
- Certified Efficiency: 8.3 % (1 cm<sup>2</sup>)
- Collaboration of Heliatek und IAPP (TU Dresden)

![](_page_28_Picture_0.jpeg)

#### **Intensity Performance**

![](_page_28_Figure_2.jpeg)

![](_page_28_Picture_3.jpeg)

#### Superior low-light performance:

97 % of full-sun efficiency at 1/10th sun

- Heliatek Absorber
- Certified Efficiency: 8.3 % (1 cm<sup>2</sup>)
- Collaboration of Heliatek und IAPP (TU Dresden)

![](_page_29_Picture_0.jpeg)

#### **Intensity Performance**

![](_page_29_Figure_2.jpeg)

#### Superior low-light performance:

97 % of full-sun efficiency at 1/10th sun

- Heliatek Absorber
- Certified Efficiency: 8.3 % (1 cm<sup>2</sup>)
- Collaboration of Heliatek und IAPP (TU Dresden)

![](_page_30_Picture_0.jpeg)

#### **Development of OPV Efficiencies**

![](_page_30_Figure_2.jpeg)

![](_page_31_Picture_0.jpeg)

#### Efficiency Outlook for Tandem Cells

0 2.000 4.000 6.000

8.000 10.00 12.00 14.00

16.00 18.00 20.00 22.00

e.gap

o.gap

e.gap

o.gap

e.gap

o.gap

first cell

1.9eV

2.1eV

~770nm

~690nm

2.225eV

~645nm

second cell

~21%

~20%

~19%

1.25eV

1,5eV

1.7eV

~890nm

~1300nm

~1030nm

Power conversion efficiency of a tandem cell (in %)

![](_page_31_Figure_3.jpeg)

T. Mueller et al.

![](_page_32_Picture_0.jpeg)

#### Lifetime of Thiophene Tandem Cells

- Collaboration between Heliatek & IAPP
- Absorber materials from BASF and Heliatek, dopants from Novaled
- Glass-glass encapsulation
- Halogen light at about 1.5 suns

![](_page_32_Figure_6.jpeg)

![](_page_32_Picture_7.jpeg)

#### **Gen2 Pilot Fabrication Line for OLED Lighting at COMEDD**

- Including lithography-free substrate structuring
- Substrate size 370 x 470 mm<sup>2</sup> (Gen2)
- Modular fully automated cluster system
- Plasma pretreatment
- Organic film deposition
  - Vacuum Thermal Evaporation VTE
  - Organic Vapor Phase Deposition OVPD
- Metal film deposition
- Direct connection to encapsulation system

![](_page_33_Picture_10.jpeg)

![](_page_33_Picture_11.jpeg)

#### Photolithography-free substrates of Gen2 size

![](_page_34_Figure_1.jpeg)

![](_page_34_Picture_2.jpeg)

© Fraunhofer IPMS

![](_page_35_Figure_0.jpeg)

![](_page_35_Picture_1.jpeg)

#### Roll to roll vacuum coater

![](_page_36_Picture_1.jpeg)

attachement possibility for a glove box

![](_page_36_Picture_3.jpeg)

deposition cylinder

#### winding units

![](_page_36_Picture_6.jpeg)

![](_page_36_Picture_7.jpeg)

![](_page_36_Picture_8.jpeg)

# OLED OPERATION TESTS UNDER INERT CONDITIONS AND AFTER LAMINATION

![](_page_37_Picture_1.jpeg)

Electrical tests after the encapsulation

![](_page_37_Picture_3.jpeg)

#### WHITE PIN OLED

![](_page_38_Picture_1.jpeg)

Transparent OLED on Polymer web

![](_page_38_Picture_3.jpeg)

© Fraunhofer IPMS

#### **OLED MICRODISPLAYS AND SENSORICS**

- Process development, integration, system integration OLED Microdisplays (small molecules (focus), polymers)
  - bi-directional OLED micro-displays (with embedded image sensor)
  - CMOS backplane IC design and CMOS/OLED interface processing (w/ CMOS foundry)
  - OLED processing (SM and PLED)
  - Encapsulation (wafer-level color filter integration)
  - System design (e.g., see-through near-to-eye display, multimedia I/F & controller)

Fabrication lines

Pilot line OLED-on-CMOS (Ø 200 mm wafer)

Pilot line PLED-Microdisplays (ex MED,  $\emptyset$  200 mm wafer)

![](_page_39_Picture_10.jpeg)

![](_page_39_Picture_11.jpeg)

![](_page_39_Picture_13.jpeg)

![](_page_39_Picture_14.jpeg)

![](_page_40_Picture_0.jpeg)

![](_page_40_Picture_1.jpeg)

![](_page_40_Picture_2.jpeg)

- Small OLED Displays have achieved commercial breakthrough
- OLED: Main issue is improving outcoupling
- Organic solar cells: Efficiencies &Lifetimes grow rapidly
- Efficient vacuum roll-to-roll manufacturing demonstrated
- Organic Electronics will be everywhere....

![](_page_41_Picture_0.jpeg)

- S. Reineke, S. Hofmann, S. Pfützner, H. Ziehlke, C. Körner, T. Menke, T. Müller, L. Burtone, D. Ray, C. Elschner, J. Meiss, M. Furno, C. Sachse, L. Müller-Meskamp, M.K. Riede, B. Lüssem, J. Widmer, M. Hummert (IAPP)
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- P. Erk (BASF) and others from OPEG
- BMBF, SMWA, SMWK, DFG, EC, FCI, NEDO